R16

Code No: **R164104D**

Set No. 1

IV B. Tech I Semester Regular Examinations, October/November - 2019 EMBEDDED SYSTEMS

(Electronics and Communication Engineering)

Time: 3 hours Max. Marks: 70 Question paper consists of Part-A and Part-B Answer ALL sub questions from Part-A Answer any FOUR questions from Part-B **** PART-A (14 Marks) 1. a) What is an embedded system? [2] b) What is current limiting Resistor in embedded application? [3] c) Write the execution steps for embedded firmware. [3] d) Define Process Management. [2] What is decompiler? e) [2] Define IDE(Integrated Development Environment) tools? [2] PART-B (4x14 = 56 Marks)Write the history of embedded system. [7] Differentiate RISC and CISC. [7] What is sequential circuit? Explain with examples. [7] 3. a) b) What are serial communication devices? Explain. [7] 4. a) Explain the advantages of assembly language based development. [7] b) Write a note on C versus embedded C and compiler versus cross compiler. [7] 5. a) What is shared memory? Explain different mechanisms are adopted to implement shared memory. [7] b) What are the building blocks of UML? Explain it. [7] Explain various elements of an embedded system development environment. [7] b) Explain the various details held by a List file generated during the process of cross-compiling an embedded C project. [7] 7. a) Explain Computer-Aided Design (CAD) and hardware. [7] b) Differentiate static and dynamic testing. [7]

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Set No. 2

IV B.Tech I Semester Regular Examinations, October/November - 2019 EMBEDDED SYSTEMS

(Electronics and Communication Engineering)

Time: 3 hours Max. Marks: 70

Question paper consists of Part-A and Part-B Answer ALL sub questions from Part-A Answer any FOUR questions from Part-B *****

PART-A (14 Marks)

1.	a)	Write the major application areas of embedded system.	[3]
	b)	Explain the usage of capacitors and inductors in embedded hardware circuit.	[3]
	c)	Write about super loop based approach.	[2]
	d)	Define file system management.	[2]
	e)	What is the difference between simulator and an emulator?	[2]
	f)	What is complier?	[2]
		PART-B (4x14 = 56 Marks)	
2.	a)	Write and explain the classification of embedded systems.	[7]
	b)	Explain the onboard communication interfaces.	[7]
3.	a)	What is Latch? Draw and explain the latch.	[7]
	b)	Explain briefly about parallel device ports.	[7]
4.	a)	Write and explain the drawbacks of assembly language based development.	[7]
	b)	What is Interrupt? Explain multiple interrupts with examples.	[7]
5.	a)	Write and explain the basic functions of real time kernel.	[7]
	b)	Explain data flow graph and state machine model in embedded design.	[7]
6.	a)	Explain the role of Integrated Development Environment (IDE) for embedded	
0.	,	Software development.	[7]
	b)	Explain the various details held by a Map file generated during the process of	
		cross-compiling an embedded C project.	[7]
7.	a)	Draw the compilation diagram and explain it.	[7]
	b)	What is testing? Explain the types of testing.	[7]
	0)	what is testing. Explain the types of testing.	[/]

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Set No. 3

IV B.Tech I Semester Regular Examinations, October/November - 2019 EMBEDDED SYSTEMS

(Electronics and Communication Engineering)

Time: 3 hours Max. Marks: 70

Question paper consists of Part-A and Part-B Answer ALL sub questions from Part-A Answer any FOUR questions from Part-B *****

PART-A (14 Marks)

		PARI-A (14 Marks)	
1.	a)	What is typical embedded system?	[2]
	b)	What is Schottky diode's role in embedded applications?	[3]
	c)	Write about super loop based design.	[3]
	d)	Define Non-Preemptive multitasking.	[2]
	e)	What is monitor program?	[2]
	f)	What is interpreter?	[2]
		$\underline{\mathbf{PART-B}} \ (4x14 = 56 \ Marks)$	
2.	a)	Explain the purpose of embedded system.	[7]
	b)	What is ROM? How the ROM classified? Explain it.	[7]
3.	a)	What is combinational circuit? Explain with example.	[7]
	b)	Explain briefly about wireless devices.	[7]
4.	a)	Explain the conversion process from source file to object file translation.	[7]
	b)	Explain briefly about interrupt servicing mechanism.	[7]
5.	a)	Define process? Draw the processor state transition diagram and explain it.	[7]
•	b)	Define message passing? Explain how the message passing is classified.	[7]
6.	a)	Explain the format of Hex records in an Intel Hex file.	[7]
	b)	What are the different techniques available for embedded firmware debugging?	
	ĺ	Explain them in detail.	[7]
7.	a)	Draw the interpretation diagram and explain it.	[7]
	b)	Explain how testing will done on host machine.	[7]

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Set No. 4

[7]

IV B.Tech I Semester Regular Examinations, October/November - 2019 EMBEDDED SYSTEMS

(Electronics and Communication Engineering) Time: 3 hours Max. Marks: 70 Question paper consists of Part-A and Part-B Answer ALL sub questions from Part-A Answer any FOUR questions from Part-B **** PART-A (14 Marks) 1. a) Differentiate Harvard architecture and Von-Neumann architecture. [3] b) How transistors are used in embedded hardware circuit? [3] c) Write the drawbacks of super loop. [2] d) Define thread. [2] What is On Chip Debugging? [2] e) What is preprocessor? f) [2] $\underline{\mathbf{PART-B}} \ (4x14 = 56 \ Marks)$ What is RAM? Explain the categories of RAM. Define sensors? Explain the I/O subsystem. [7] 3. a) What is multiplexer (mux)? Explain it. [7] Explain briefly about watchdog timer. [7] Write and explain the advantages of high level based development. 4. [7] Discuss the Mixing Assembly with high level language and mixing high level language with assembly. [7] 5. a) What is deadlock? List and explain different conditions favoring a deadlock [7] b) Explain the fundamental issues in hardware software co-design. [7] a) What is the difference between assembler and disassembler? State their uses in embedded application development. [7] b) Explain the Boundary Scan based hardware debugging in details. [7] 7. a) What is debugging tool? Explain it. [7]

b) Discuss Simulators and Laboratory tools in details